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**COMMUNICATION DEVICES, COMMUNICATION
SYSTEMS AND METHODS OF COMMUNICATING**

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1 COMMUNICATION DEVICES, COMMUNICATION SYSTEMS AND
2 METHODS OF COMMUNICATING

3 TECHNICAL FIELD

4 The present invention relates to communication devices,
5 communication systems and methods of communicating, and more
6 particularly to radio frequency communication devices.

7
8 BACKGROUND OF THE INVENTION

9 Electronic identification systems typically comprise two devices
10 which are configured to communicate with one another. Preferred
11 configurations of the electronic identification systems are operable to
12 provide such communications via a wireless medium.

13 One such configuration is described in U.S. Patent Application
14 Serial Number 08/705,043, filed August 29, 1996, assigned to the
15 assignee of the present application and incorporated herein by reference.
16 This application discloses the use of a radio frequency (RF)
17 communication system including communication devices. The disclosed
18 communication devices include an interrogator and a transponder, such
19 as a tag or card.

20 Such communication systems can be used in various identification
21 functions and other applications. The interrogator is configured to
22 output a polling signal which may comprise a radio frequency signal
23 including a predefined code. The transponders of such a communication
24 system are operable to transmit an identification signal responsive to

1 receiving an appropriate command or polling signal. More specifically,
 2 the appropriate transponders are configured to recognize the predefined
 3 code. The transponders receiving the code subsequently output a
 4 particular identification signal which is associated with the transmitting
 5 transponder. Following transmission of the polling signal, the
 6 interrogator is configured to receive the identification signals enabling
 7 detection of the presence of corresponding transponders.

8 Such communication systems are useable in identification
 9 applications such as inventory or other object monitoring. For example,
 10 a remote identification device is attached to an object of interest.
 11 Responsive to receiving the appropriate polling signal, the identification
 12 device is equipped to output an identification signal. Generating the
 13 identification signal identifies the presence or location of the
 14 identification device and the article or object attached thereto.

15 It is preferred to maximize communication range between
 16 communication devices of the identification system while providing robust
 17 communications. Increasing the range also increases the applications of
 18 the identification system. Providing robust communications ensures
 19 reliability and integrity of the system.

20 However, limitations exist upon the wireless communication
 21 components utilized within the communication devices. For example,
 22 given the nature of use of such electronic devices (i.e., attachment of
 23 the transponder to other devices or objects), it is preferred to minimize
 24 the size of the electronic device. Compact electronic devices also have

1 cosmetic and utilitarian advantages over larger conventional
2 communication devices. Size limitations impose limitations upon the
3 wireless communication components themselves. In addition, the Federal
4 Communication Commission also imposes power limits upon the wireless
5 communication components.

6 Therefore, it is desirable to provide an identification device which
7 achieves the benefits of increased range and robust wireless
8 communications in consideration of size and power limitations.

9
10 SUMMARY OF THE INVENTION

11 According to one aspect, the present invention provides a
12 communication device including a first antenna operable to receive
13 wireless communication signals and a second antenna having plural leads
14 and operable to output wireless communication signals. The
15 communication device further comprises a connection coupled with the
16 second antenna and a switch. The switch is operable to provide
17 selective shorting, and insulation or electrical isolation of leads of the
18 second antenna. The connection provides low load impedance of the
19 second antenna during receiving of wireless communication signals in a
20 preferred embodiment of the invention.

21 According to some embodiments of the invention, the
22 communication devices comprise one of a radio frequency identification
23 device and a remote intelligent communication device.
24

Another communication device of the present invention includes a first antenna operable to receive wireless communication signals and a second antenna operable to output wireless communication signals. The second antenna is selectively configured between high load impedance and low load impedance. The communication device includes a switch selectively operable to electrically short and insulate the leads. Further, a transformer is provided intermediate the switch and the second antenna and the transformer is configured to provide low load impedance of the second antenna responsive to the switch being open.

The present invention also provides a communication system including an interrogator and a communication device configured to communicate with the interrogator. The communication device includes a first antenna operable to receive wireless signals from the interrogator and a second antenna operable to output wireless signals to the interrogator. The communication device also includes a connection configured to provide a low load impedance of the second antenna during receiving of wireless signals using the first antenna.

One method of communicating according to the present invention includes forming a first antenna, forming a second antenna, receiving wireless interrogation signals using the first antenna and outputting wireless identification signals using the second antenna. The method also provides opening a coupling intermediate plural leads of the second antenna during the receiving, selectively shorting the leads of the second antenna during the outputting, and providing a low load impedance of

1 the second antenna during the receiving. Methods according to
2 additional aspects of the invention also provide beam forming using the
3 first and second antennas.

4 5 BRIEF DESCRIPTION OF THE DRAWINGS

6 Preferred embodiments of the invention are described below with
7 reference to the following accompanying drawings.

8 Fig. 1 is a functional block diagram illustrating a wireless
9 communication system.

10 Fig. 2 is a top plan view of one embodiment of a communication
11 device of the communication system of Fig. 1.

12 Fig. 3 is a top plan view of the communication device at an
13 intermediate processing step.

14 Fig. 4 is a bottom view of the communication device at an
15 intermediate processing step.

16 Fig. 5 is a diagrammatic representation of antennas of the
17 communication device.

18 Fig. 6 is a diagrammatic representation, similar to Fig. 5, of the
19 communication device.

20 Fig. 7 is a schematic diagram of one embodiment of a backscatter
21 switch of the communication device.

22 Fig. 8 is a gain plot of a receive antenna of the communication
23 device.
24

1 Fig. 9 is a gain plot of the receive antenna of the communication
2 device illustrating enhanced gain.

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4 **DETAILED DESCRIPTION OF THE PREFERRED EMBODIMENTS**

5 This disclosure of the invention is submitted in furtherance of the
6 constitutional purposes of the U.S. Patent Laws "to promote the
7 progress of science and useful arts" (Article 1, Section 8).

8 The present invention provides electronic devices configured to
9 communicate via wireless communication signals, such as radio frequency
10 signals. The present invention additionally provides methods of
11 communicating.

12 Some embodiments of the electronic devices include electronic
13 communication devices such as wireless identification devices. Exemplary
14 electronic communication devices include radio frequency identification
15 devices (RFID) and remote intelligent communication devices (RIC). A
16 remote intelligent communication device is capable of functions other
17 than the identifying function of a radio frequency identification device.
18 A preferred remote intelligent communication device includes a
19 processor.

20 Some communication devices disclosed herein are implemented
21 upon printed circuit boards (PCBs) according to described aspects of the
22 present invention. The disclosed embodiments are illustrative and other
23 configurations including encapsulated devices which utilize features of the
24 present invention are possible.

Referring to Fig. 1, a communication system is illustrated. Although the communication system is described with reference to a wireless identification system 12, the present invention is implemented in other configurations in accordance with other embodiments. The depicted identification system 12 includes a remote communication device 10, such as a remote intelligent communication device or a radio frequency identification device, and an interrogator unit 14. Typically, plural communication devices 10 are provided to communicate with interrogator unit 14. An exemplary wireless identification system 12 is described in U.S. Patent Application Serial Number 08/705,043, incorporated by reference above. An exemplary interrogator 14 is described in detail in U.S. Patent Application Serial Number 08/806,158, filed February 25, 1997, assigned to the assignee of the present application and incorporated herein by reference.

Communication device 10 is configured to communicate via electromagnetic signals with interrogator unit 14. Preferably, device 10 communicates with interrogator unit 14 via wireless electromagnetic signals, such as radio frequency (RF) signals. Wireless electromagnetic signals or radio frequency signals, such as microwave signals, are utilized for communications in the preferred embodiment of identification system 12. Interrogator unit 14 further includes an antenna 16 to facilitate wireless communications.

In one embodiment of the identification system 12, interrogator 14 outputs an interrogation signal via antenna 16 during forward link

1 communications. The interrogation signal is received and processed by
2 any communication devices 10 within the transmission range of
3 interrogator 14. Following processing, appropriate communication
4 devices 10 are configured to return an identification signal during return
5 link communications. The identification signal identifies the individual
6 device 10 transmitting the identification signal in one embodiment of the
7 invention.

8 Referring to Fig. 2, one embodiment of communication device 10
9 is shown. Communication device 10 includes a base substrate 18 which
10 comprises a printed circuit board in the described embodiment. Other
11 substrates, such as a flexible polyester film, are utilized in other
12 embodiments. Substrate 18 includes a first surface 20 shown in Fig. 2.
13 Substrate 18 also includes a second surface 22 (shown in Fig. 4)
14 opposite first surface 20.

15 Communication device 10 includes plural components mounted
16 upon first surface 20. Such components include an integrated circuit 24,
17 and first and second power supplies 26, 28 in one embodiment. Other
18 power supply configurations may be utilized. A conductive trace or
19 pattern 37 is provided upon first surface 20 to provide electrical
20 interconnection of the components. Conductive pattern 37 includes
21 conductors 40, 42, 46, 48 to provide electrical interconnection.

22 Further, the illustrated conductive pattern 37 includes a first
23 antenna 30 and second antenna 32 for implementing wireless
24 communications. First antenna 30 is also referred to as a receive or

1 forward link antenna and second antenna 32 is also referred to as a
2 transmit or return link antenna. Conductive pattern 37 comprises
3 copper in one embodiment of the invention. Other materials are
4 utilized in other embodiments to form conductive pattern 37.

5 One embodiment of integrated circuit 24 includes suitable
6 communication circuitry within communication device 10 for providing
7 wireless communications. For example, in one embodiment, integrated
8 circuit 24 includes a microprocessor 65, memory 67, and transponder
9 circuitry 68 in cooperation with one another for providing wireless
10 communications with interrogator unit 14. An exemplary and preferred
11 integrated circuit 24 is described in U.S. Patent Application Serial
12 08/705,043 incorporated by reference above. The illustrated integrated
13 circuit 24 is packaged in a conventional small outline (SOIC) package.

14 One embodiment of the communication circuitry or transponder
15 circuitry 68 includes a modulator, such as a transmitter, and a receiver
16 operable to respectively communicate (i.e., output) and receive wireless
17 electronic signals. The microprocessor 65 is coupled with transponder
18 circuitry 68 and is configured to process the electronic signals.
19 Responsive to the detection of an appropriate interrogation or polling
20 signal, microprocessor 65 instructs transponder circuitry 68 to output the
21 identification signal. The modulator comprises an active transmitter or
22 a backscatter device according to certain embodiments. Such outputting
23 or communicating of the communication signals via the modulator
24

1 comprises one of transmitting electromagnetic signals and reflecting
2 received signals.

3 Plural power supplies 26, 28 are provided in the described
4 embodiment of communication device 10. A single power supply is
5 utilized in other embodiments. The illustrated power supplies 26, 28
6 are connected in series to provide operational power to components of
7 communication device 10. Power supplies 26, 28 provide power at
8 approximately 6 volts to components of communication device 10. The
9 illustrated power supplies 26, 28 comprise batteries although other power
10 sources may be utilized.

11 Brackets 36, 38 are elevated from first surface 20 and are
12 configured to hold respective power supplies 26, 28 upon substrate 18.
13 Perimetral edges of power supplies 26, 28 form positive or power
14 terminals. Upper surfaces (i.e., facing away from surface 20) of power
15 supplies 26, 28 also form the positive terminals. Brackets 36, 38
16 provide electrical coupling with the positive terminals at edges 27, 29
17 and the upper surfaces of power supplies 26, 28. Brackets 36, 38 are
18 formed of stainless steel in the described embodiment of the invention.
19 Alternatively, other conductive materials may be utilized to fabricate
20 brackets 36, 38.

21 The device 10 includes plural vias which extend through respective
22 brackets 36, 38 and substrate 18. A first via receives a conductive
23 post 53. Post 53 provides electrical coupling of the elevated bracket 38
24 to first surface 20 of substrate 18. Post 53 is electrically coupled with

1 conductor 40. Positive power from power supplies 26, 28 is applied to
2 capacitor 34 and integrated circuit 24 via post 53 and conductor 40.

3 Conductor 42 provides electrical coupling of the negative terminal
4 of power supply 26 with integrated circuit 24. Conductor 42 is coupled
5 with a pad 54 (shown in Fig. 3) provided below power supply 26.
6 Conductor 42 is insulated from bracket 36.

7 The positive terminal of power supply 26 is electrically coupled
8 with the negative terminal of power supply 28. A via is provided
9 through bracket 36 and substrate 18. A conductive post 50 is provided
10 within the via and electrically couples bracket 36 with the second
11 surface 22 of substrate 18. Referring to Fig. 4, a conductor 58 upon
12 second surface 22 is coupled with post 50. Another conductive post 55
13 provides electrical coupling of conductor 58 at second surface 22 with
14 an electrical pad 56 upon first surface 18 (shown in Fig. 3). Post 55
15 is provided within a via formed through substrate 18 and is coupled
16 with pad 56 and the negative terminal of power source 28.

17 Referring again to Fig. 2, first antenna 30 and second antenna 32
18 are formed upon first surface 20 of substrate 18. First antenna 30 is
19 also referred to as a forward link or receive antenna operable to
20 receive wireless communication signals. First antenna 30 comprises a
21 loop antenna in the illustrated embodiment. Other antenna
22 configurations are possible for first antenna 30.

23 Conductors 46, 48 operate to couple first antenna 30 with plural
24 IC connections 63, 69 of integrated circuit 24. IC connections 63, 69

1 provide an RX input to transponder 68. The RX input has an
2 impedance of about 50 Ohms (real) and is invariant in the described
3 embodiment. Thus, receive antenna 30 sees a constant load of
4 about 50 Ohms. Receive antenna 30 and RX input are "matched" in
5 a preferred embodiment to provide maximum RF voltage to the RX
6 input.

7 Second antenna 32 is formed as a dipole antenna including
8 portions or halves 33, 35 upon first surface 20 of substrate 18. Second
9 antenna 32 may be also referred to as a return link antenna or
10 transmit antenna and is operable to output wireless signals.
11 Halves 33, 35 of antenna 32 have corresponding lengths appropriate for
12 the desired transmission frequency. In the illustrated embodiment,
13 halves 33, 35 of the dipole antenna 32 have respective sizes appropriate
14 for 2.45 GHz communications. Second antenna 32 is formed in other
15 configurations in other embodiments.

16 Second antenna 32 includes plural leads 44, 45 for connection to
17 integrated circuit 24. In one embodiment, a connection 60 (shown in
18 Fig. 4) is utilized to couple leads 44, 45 of second antenna 32 with
19 plural IC connections 64, 66 of integrated circuit 24 as described in
20 detail below. Connection 60 is also referred to herein as a coupler or
21 transformer.

22 Conductors 46, 48 of trace 37 are formed upon first surface 20
23 of substrate 18 to connect leads 44, 45 of first antenna 30 with
24 integrated circuit 24. In one embodiment of the invention,

conductors 46, 48 individually have a predefined length to separate first antenna 30 and second antenna 32 by a distance d_1 . In one embodiment of the invention, distance d_1 is approximately equal to the wavelength of the wireless communication signals. Communication device 10 and interrogator unit 14 of system 12 are operable to communicate via wireless signals having a frequency of 2.45 GHz in the described embodiment. The lengths of conductors 46, 48 may be adjusted for utilization of other communication frequencies.

Separating first antenna 30 and second antenna 32 by a distance approximately equal to the wavelength of the wireless communication signals beam forms receive antenna 30 to a desired direction. Such interacting and beam forming (phase tuning) of antennas 30, 32 enhances the gain of both antennas 30, 32. The amount of interaction between antennas 30, 32 depends upon the spacing of the antennas 30, 32 (i.e., distance d_1) and the impedance load of antennas 30, 32. Adjusting spacing d_1 adjusts the phase tuning of antennas 30, 32.

Referring to Fig. 3, first surface 20 of substrate 18 is shown with the components removed. Positioning of brackets 36, 38 for coupling with power electrodes of power sources 26, 28 is shown in phantom. Further, positioning of integrated 24 and capacitor 34 are also shown in phantom on first surface 20. Capacitor 34 is provided in the illustrated embodiment to reduce noise in the wireless communications.

1 Conductive pattern 37 includes pads 54, 56 for coupling with
2 respective power supplies 26, 28. In the described embodiment, the
3 negative terminals of power supplies 26, 28 are electrically coupled with
4 pads 54, 56, respectively. In particular, battery brackets 36, 38 utilize
5 spring tension to couple power supplies 26, 28 with pads 54, 56. The
6 negative terminals are soldered or attached to pads 54, 56 by conductive
7 epoxy in alternative embodiments. Other attachment methods may also
8 be utilized.

9 As shown in Fig. 3, plural vias are provided within leads 44, 45
10 of second antenna 32 and through substrate 18. Conductive
11 posts 47, 49 are inserted through the vias and electrically coupled with
12 respective leads 44, 45 of second antenna 32. Posts 47, 49 are
13 provided to electrically couple first surface 20 with second surface 22
14 of substrate 18.

15 Plural vias are also provided through substrate 18 for electrical
16 connection with IC connections 64, 66 of integrated circuit 24.
17 Conductive posts 23, 25 are provided within vias adjacent integrated
18 circuit 24 to provide electrical connection intermediate first surface 20
19 and second surface 22 of substrate 18. A connection 60 (shown in
20 Fig. 4) is utilized adjacent second surface 22 to couple conductive
21 posts 47, 49 with respective conductive posts 23, 25.

22 Referring to Fig. 4, second surface 22 of substrate 18 is shown.
23 A second conductive trace or pattern 57 is formed upon second
24 surface 22. Conductive trace 57 includes a conductor 58, connection

1 plane 59 and connection 60. Second conductive trace 57 is formed of
2 copper in one embodiment. Other conductive materials are utilized in
3 other embodiments. Plane 59 is spaced relative to conductors 46, 48
4 provided upon first surface 20 of substrate 18 and is configured to float
5 at a voltage of approximately 3.2 volts.

6 Conductor 58 electrically couples conductive post 50 with post 55.
7 Conductor 58 provides electrical coupling of the positive terminal of
8 power source 26 with the negative terminal of power source 28 through
9 bracket 36, posts 50, 55 and pad 56.

10 Connection 60 comprises plural conductive lines 61, 62 in the
11 illustrated embodiment. Lines 61, 62 include respective first ends and
12 second ends. First ends of lines 61, 62 are coupled with leads 44, 45
13 of second antenna 32, respectively. Second ends of lines 61, 62 are
14 coupled with IC connections 64, 66, respectively.

15 First line 61 is configured to electrically couple conductive
16 posts 23, 47 and second line 62 is configured to electrically couple
17 conductive posts 25, 49. Posts 47, 49 are electrically coupled with
18 leads 44, 45 of second antenna 32. Posts 23, 25 are electrically
19 coupled with IC connections 64, 66 (shown in Fig. 2) of integrated
20 circuit 24.

21 In one embodiment of the invention, lines 61, 62 are parallel and
22 configured as transmission lines. Lines 61, 62 have a predefined
23 distance d_2 between second antenna 32 and transponder 68. The
24

1 distance d_2 is equal to approximately one quarter the wavelength of the
2 wireless communication signals in the described embodiment.

3 Provision of connection 60 as a quarter wave transmission line
4 coupled with second antenna 32 forms a parasitic antenna element that
5 interacts favorably with receive antenna 30 to enhance the receive
6 antenna gain. As described in detail below, quarter wavelength
7 connection 60 operates as a transformer to transform high load
8 impedance for second antenna 32 to low load impedance. Providing
9 low load impedance during receive operations within device 10 provides
10 maximum interaction of transmit antenna 32 with receive antenna 30
11 (beam forming) and provides the desired enhancement.

12 Referring to Fig. 5, the modulator of transponder 68 within
13 integrated circuit 24 includes plural antenna ports BS1 and BS2 which
14 are electrically coupled with connections 64, 66 of integrated circuit 24.
15 Antenna ports BS1 and BS2 provide backscatter connections with
16 transponder 68. Connection 60 electrically couples antenna 32 with
17 antenna ports BS1 and BS2.

18 Antenna ports BS1 and BS2 (IC connections 64, 66) form an
19 impedance gap in the described embodiment. Antenna ports BS1
20 and BS2 are additionally coupled with a switch 70 provided within
21 integrated circuit 24. Switch 70 is referred to as a backscatter switch
22 in some embodiments. Switch 70 is operable to selectively short IC
23 connections 64, 66 or insulate (e.g., electrically isolate) IC
24 connections 64, 66 by opening a coupling between IC

connections 64, 66. Microprocessor 65 is configured to operate switch 70 in one embodiment of the invention.

Switch 70 is illustrated as closed in Fig. 5 thereby shorting IC connections 64, 66 across the impedance gap. Switch 70 is referred to as closed or "on" when IC connections 64, 66 are shorted. The load impedance of second antenna 32 is low (approximately 30 Ohms in the described embodiment) when switch 70 is on.

Referring to Fig. 6, switch 70 is open providing a high impedance gap intermediate antenna ports BS1, BS2 (IC connections 64, 66). Switch 70 is referred to as open or "off" when IC connections 64, 66 are not electrically coupled via switch 70. The load impedance of second antenna 32 is high (approximately 150 Ohms in the described embodiment) responsive to switch 70 being off.

Referring to Fig. 7, one embodiment of a suitable switch 70 of integrated circuit 24 is shown. Switch 70 is coupled with IC connections 64, 66 (ports BS1, BS2). Switch 70 includes an n-channel transistor 72 and two n-channel pull-up transistors 74, 76. Transistors 74, 76 are respectively connected between a drain voltage Vdd and transistor 72.

When the gate of transistor 72 is high (switch 70 being on), then the two halves 33, 35 of antenna 32 are shorted together with a fairly low impedance via IC connections 64, 66 and connection 60. Second antenna 32 becomes substantially similar to a single half-wavelength antenna responsive to switch 70 being on or closed. In a backscatter

1 mode of operation, when halves 33, 35 of antenna 32 are shorted
2 together, second antenna 32 reflects a portion of the power being
3 transmitted by interrogator 14.

4 When the gate of transistor 72 is low (switch 70 being off), then
5 transistor 72 is off, and transistors 74, 76 are on. Turning
6 transistors 74, 76 on lifts antenna ports BS1 and BS2 both up to
7 approximately the drain voltage of Vdd. The two antenna
8 ports BS1, BS2 and halves 33, 35 of second antenna 32 are isolated
9 from one another by an open circuit. Second antenna 32 becomes
10 substantially similar to two quarter wavelength antennas when switch 70
11 is off. In a backscatter mode of operation and the two halves 33, 35
12 of second antenna 32 are isolated, antenna 32 reflects very little of the
13 power transmitted by interrogator 14.

14 Integrated circuit 24 includes control circuitry 78 in one
15 embodiment for controlling switch 70 between an on state and off state.
16 Control circuitry 78 includes cross-coupled circuitry in one embodiment
17 of the invention. Such cross-coupled circuitry is provided to make sure
18 that both the pull up transistors 74, 76 and the shorting device
19 (transistor 72) are not on at the same time.

20 The modulated backscatter transmitter further includes another
21 antenna port (not shown) that is intended to be used when integrated
22 circuit 24 is packaged in the standard SOIC package. The additional
23 antenna port provides another option for configuring a backscatter
24 antenna. The additional antenna port is configured to supply a one

1 milliamper current that can drive an external PIN diode that would be
2 situated between the two halves 33, 35 of the dipole antenna 32 or any
3 other suitable antenna. The other side of that external PIN diode can
4 be returned to either existing antenna port BS1 or BS2.

5 During return link (i.e., reply mode) operations, switch 70 is
6 turned off and on at a specified rate to form a digital return signal to
7 interrogator 14. Turning switch 70 on and off changes the load
8 impedance of second antenna 32. Switch 70 is off during forward link
9 (i.e., receive mode) operations.

10 Maximum interaction (beam forming) of first antenna 30 and
11 second antenna 32 occurs when second antenna 32 has a low load
12 impedance value. However, switch 70 is off (open) during receive
13 mode. Connection 60 operates as a transformer to transform high load
14 impedance of second antenna 32 (responsive to switch 70 being off) into
15 low load impedance during receive mode. Utilization of connection 60
16 effectively reverses the on/off states of switch 70 to off/on states.
17 Provision of connection 60 intermediate second antenna 32 and antenna
18 ports BS1 and BS2 provides low load impedance for second antenna 32
19 when switch 70 is off. Providing low load impedance yields maximum
20 interaction of second antenna 32 with first antenna 30 in receive mode,
21 enhancement of the receive gain of first antenna 30 and enhancement
22 of communication range of communication device 10 in general.

23 In the described embodiment, first antenna 30 and second
24 antenna 32 are beam formed in forward and backward directions normal

1 to first surface 20 of substrate 18 (the surface containing both
2 antennas 30, 32). The forward direction faces away from first
3 surface 20 of substrate 18 and the backward direction faces away from
4 second surface 22 of substrate 22. Antennas 30, 32 are arranged in
5 other configurations (e.g., other spacings d_1 are utilized) to beam form
6 antennas 30, 32 in other directions in alternative embodiments.

7 Referring to Fig. 8, a gain plot for the receive or first
8 antenna 30 is shown. This figure illustrates the normal gain of a loop
9 receive antenna 30 by itself. The directivity equals
10 approximately 3.2 dB.

11 Referring to Fig. 9, a gain plot for the receive antenna 30 beam
12 formed with the transmit antenna 32 according to the present invention
13 is shown and demonstrates the enhanced gain. The directivity is
14 approximately 5.3 dB. The gain plot of Fig. 9 illustrates an
15 enhancement of receive antenna gain by 2-3 dB. The beam of receive
16 antenna 30 is more narrowly focused with the use of transmission line
17 connection 60 as shown in Fig. 9, compared with the beam of the
18 receive antenna 30 only shown in Fig. 8.

19 In compliance with the statute, the invention has been described
20 in language more or less specific as to structural and methodical
21 features. It is to be understood, however, that the invention is not
22 limited to the specific features shown and described, since the means
23 herein disclosed comprise preferred forms of putting the invention into
24 effect. The invention is, therefore, claimed in any of its forms or

1 modifications within the proper scope of the appended claims
2 appropriately interpreted in accordance with the doctrine of equivalents.
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